N-Channel Power MOSFET

60V, 111A, 6mΩ

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and R_g Tested
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

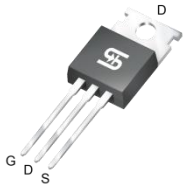
APPLICATIONS

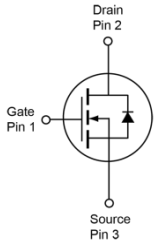
- BLDC Motor Control
- Battery Power Management
- DC-DC Converter
- Secondary Synchronous Rectification

KEY PERFORMANCE PARAMETERS			
PARAMETER		**VALUE**	**UNIT**
V_{DS}		60	V
$R_{DS(on)}$ (max)	V_{GS} = 10V	6	mΩ
	V_{GS} = 7V	8.4	
Q_g		103	nC

Pb-Free RoHS COMPLIANT HALOGEN FREE

TO-220





ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (Note 1)	T_C = 25°C	I_D	111	A
	T_A = 25°C		13	
Pulsed Drain Current		I_{DM}	444	A
Single Pulse Avalanche Current (Note 2)		I_{AS}	39	A
Single Pulse Avalanche Energy (Note 2)		E_{AS}	228	mJ
Total Power Dissipation	T_C = 25°C	P_D	156	W
	T_C = 125°C		31	
Total Power Dissipation	T_A = 25°C	P_D	2	W
	T_A = 125°C		0.4	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE			
PARAMETER	**SYMBOL**	**MAXIMUM**	**UNIT**
Junction to Case Thermal Resistance	$R_{\Theta JC}$	0.8	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	62	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JC}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design.

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	BV_{DSS}	60	--	--	V
Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	$V_{GS(TH)}$	2	3	4	V
Gate-Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Drain-Source Leakage Current	V_{GS} = 0V, V_{DS} = 60V	I_{DSS}	--	--	1	μA
	V_{GS} = 0V, V_{DS} = 60V T_J = 125°C		--	--	100	
Drain-Source On-State Resistance (Note 3)	V_{GS} = 10V, I_D = 13A	$R_{DS(on)}$	--	4.7	6	mΩ
	V_{GS} = 7V, I_D = 11A		--	5.1	8.4	
Forward Transconductance (Note 3)	V_{DS} = 10V, I_D = 13A	g_{fs}	--	62	--	S
Dynamic (Note 4)						
Total Gate Charge	V_{GS} = 10V, V_{DS} = 30V, I_D = 13A	Q_g	--	103	--	nC
Total Gate Charge	V_{GS} = 7V, V_{DS} = 30V, I_D = 11A	Q_g	--	74	--	
Gate-Source Charge		Q_{gs}	--	35	--	
Gate-Drain Charge		Q_{gd}	--	19	--	
Input Capacitance	V_{GS} = 0V, V_{DS} = 30V, f = 1.0MHz	C_{iss}	--	6842	--	pF
Output Capacitance		C_{oss}	--	387	--	
Reverse Transfer Capacitance		C_{rss}	--	115	--	
Gate Resistance	f = 1.0MHz	R_g	0.6	1.9	3.8	Ω
Switching (Note 4)						
Turn-On Delay Time	V_{GS} = 10V, V_{DS} = 30V, I_D = 13A, R_G = 2Ω	$t_{d(on)}$	--	19	--	ns
Turn-On Rise Time		t_r	--	51	--	
Turn-Off Delay Time		$t_{d(off)}$	--	65	--	
Turn-Off Fall Time		t_f	--	35	--	
Source-Drain Diode						
Forward Voltage (Note 3)	V_{GS} = 0V, I_S = 13A	V_{SD}	--	--	1	V
Reverse Recovery Time	I_S = 13A, dI/dt = 100A/μs	t_{rr}	--	28	--	ns
Reverse Recovery Charge		Q_{rr}	--	27	--	nC

Notes:

1. Silicon limited current only.
2. L = 0.3mH, V_{GS} = 10V, V_{DD} = 30V, R_G = 25Ω, I_{AS} = 39A, Starting T_J = 25°C
3. Pulse test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
4. Switching time is essentially independent of operating temperature.

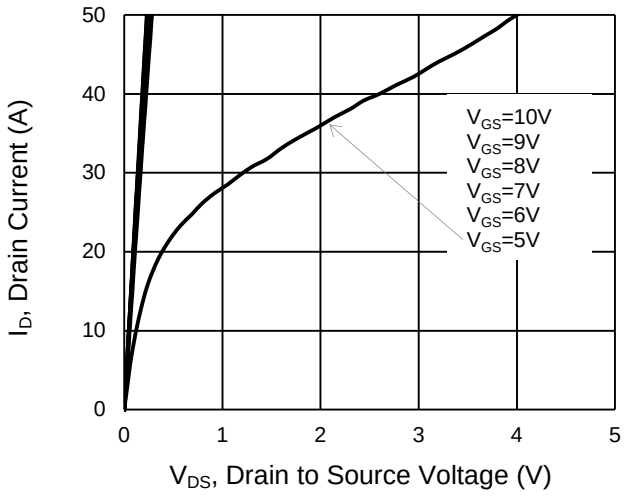
ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSM060NB06CZ C0G	TO-220	50pcs / Tube

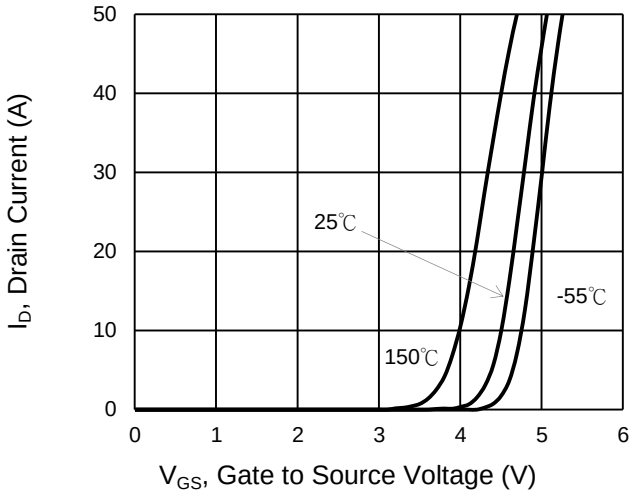
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

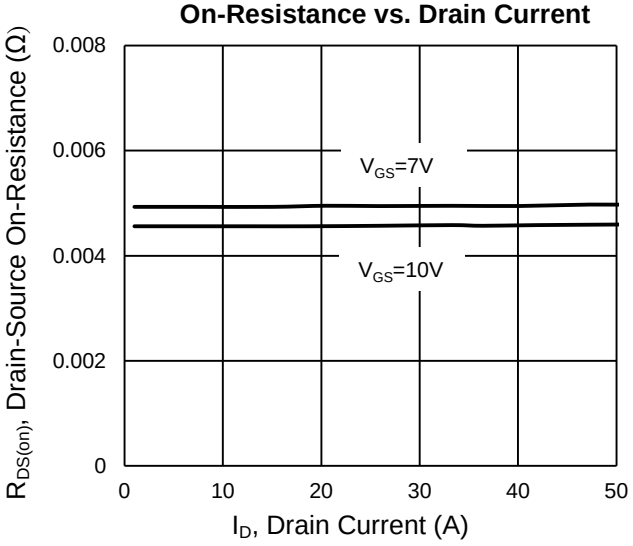
Output Characteristics



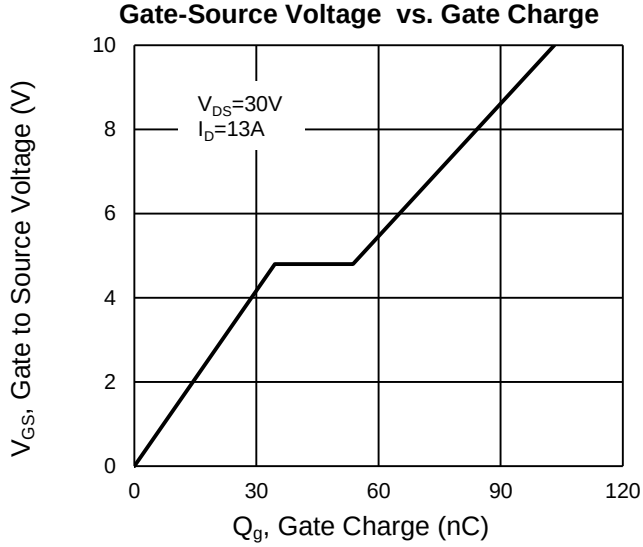
Transfer Characteristics



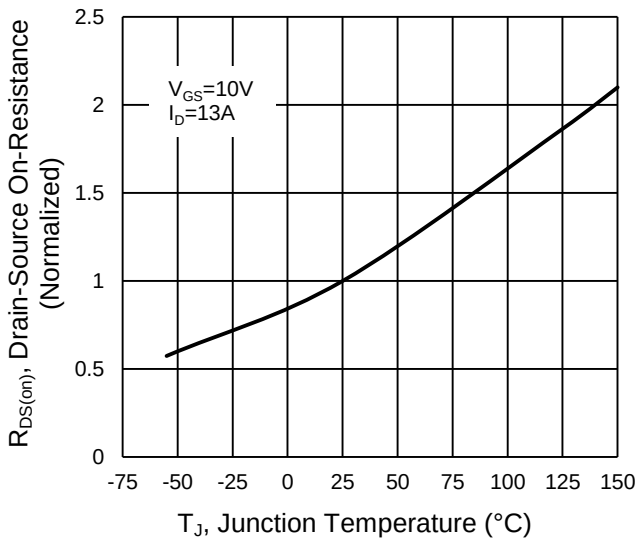
On-Resistance vs. Drain Current



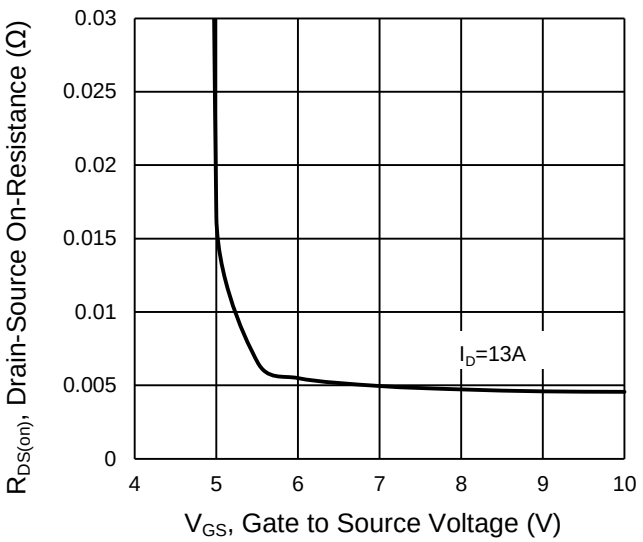
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



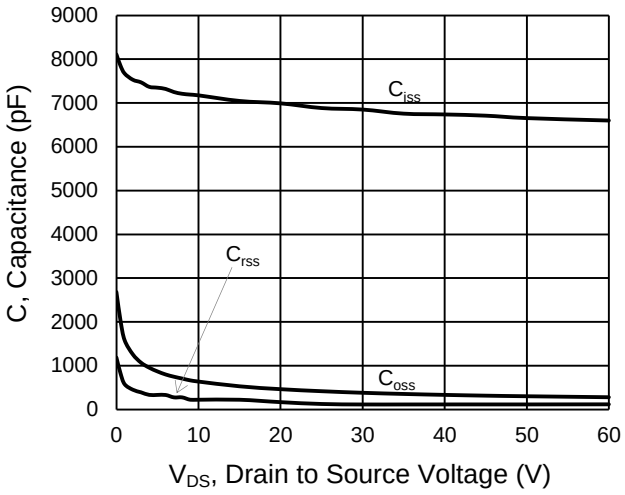
On-Resistance vs. Gate-Source Voltage



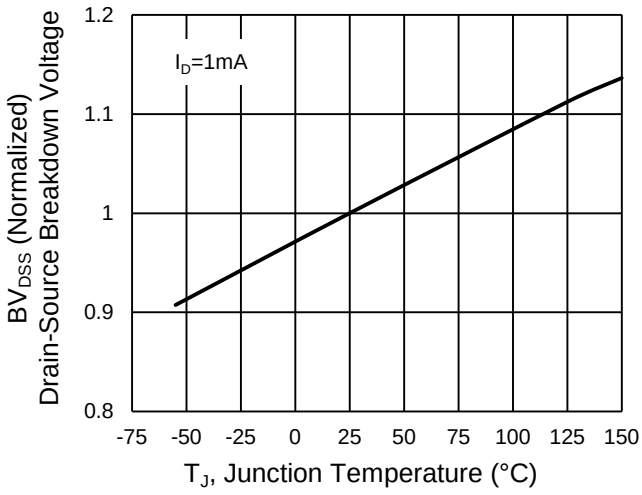
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

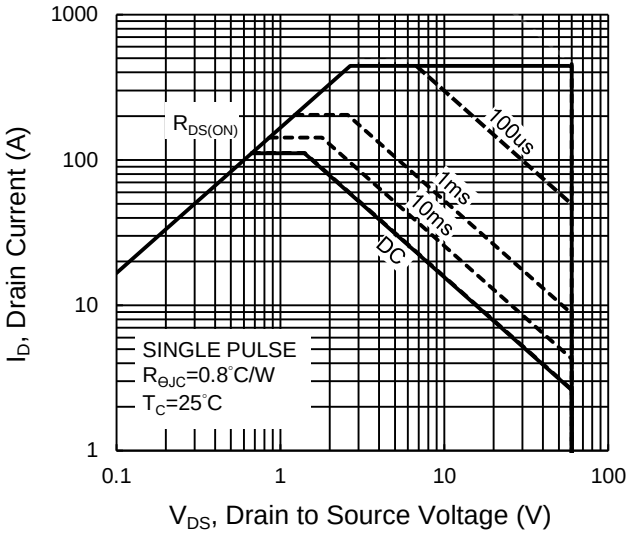
Capacitance vs. Drain-Source Voltage



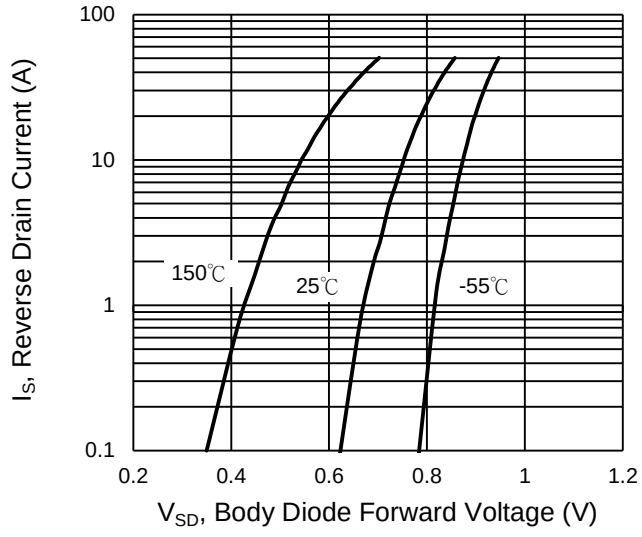
BV_{DSS} vs. Junction Temperature



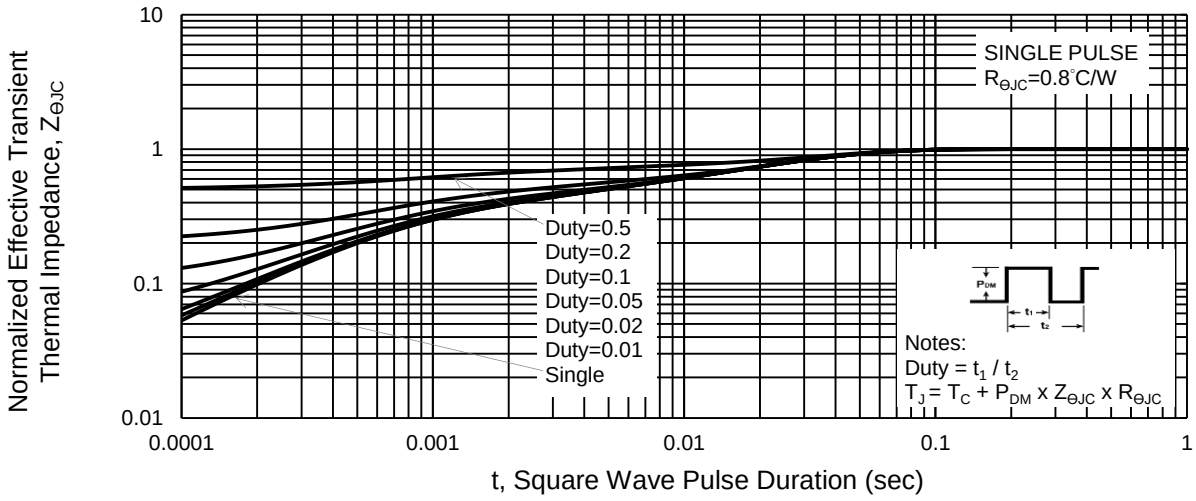
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

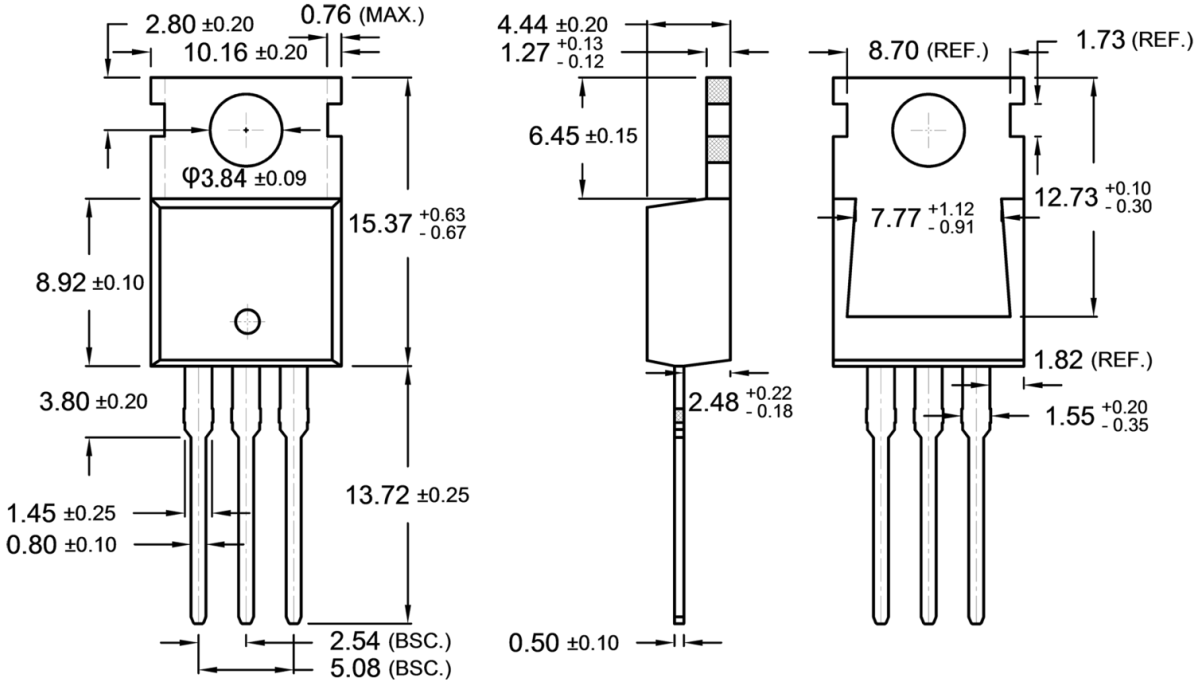


Normalized Thermal Transient Impedance, Junction-to-Case

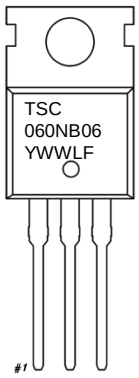


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

TO-220



MARKING DIAGRAM



Y = Year Code
WW = Week Code (01~52)
L = Lot Code (1~9,A~Z)
F = Factory Code

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